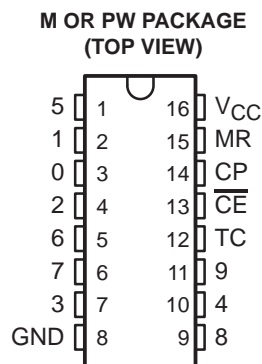


CD74HC4017-Q1 HIGH-SPEED CMOS LOGIC DECADE COUNTER/DIVIDER WITH 10 DECODED OUTPUTS

SCLS546 – OCTOBER 2003

- Qualification in Accordance With AEC-Q100†
- Qualified for Automotive Applications
- Customer-Specific Configuration Control Can Be Supported Along With Major-Change Approval
- Fully Static Operation
- Buffered Inputs
- Common Reset
- Positive Edge Clocking
- Typical $f_{MAX} = 60$ MHz at $V_{CC} = 5$ V, $C_L = 15$ pF, $T_A = 25^\circ\text{C}$
- Fanout (Over Temperature Range)
 - Standard Outputs . . . 10 LSTTL Loads
 - Bus Driver Outputs . . . 15 LSTTL Loads
- Balanced Propagation Delay and Transition Times
- Significant Power Reduction Compared to LSTTL Logic ICs
- V_{CC} Voltage = 2 V to 6 V
- High Noise Immunity N_{IL} or $N_{IH} = 30\%$ of V_{CC} , $V_{CC} = 5$ V



† Contact factory for details. Q100 qualification data available on request.

description/ordering information

The CD74HC4017 is a high-speed silicon-gate CMOS 5-stage Johnson counter with ten decoded outputs. Each of the decoded outputs normally is low and sequentially goes high on the low-to-high transition clock period of the ten-clock-period cycle. The carry (TC) output transitions low to high after output 9 goes from high to low, and can be used in conjunction with the clock enable (\overline{CE}) input to cascade several stages. \overline{CE} disables counting when in the high state. A master reset (MR) input also is provided that, when taken high, sets all the decoded outputs, except output 0, to low.

The device can drive up to ten low-power Schottky equivalent loads.

ORDERING INFORMATION

T_A	PACKAGE‡		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 125°C	SOIC – M	Tape and reel	CD74HC4017QM96Q1	HC4017Q
	TSSOP – PW	Tape and reel	CD74HC4017QPWRQ1	HC4017Q

‡ Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 2003, Texas Instruments Incorporated

CD74HC4017-Q1
HIGH-SPEED CMOS LOGIC DECADE COUNTER/DIVIDER
WITH 10 DECODED OUTPUTS

SCLS546 – OCTOBER 2003

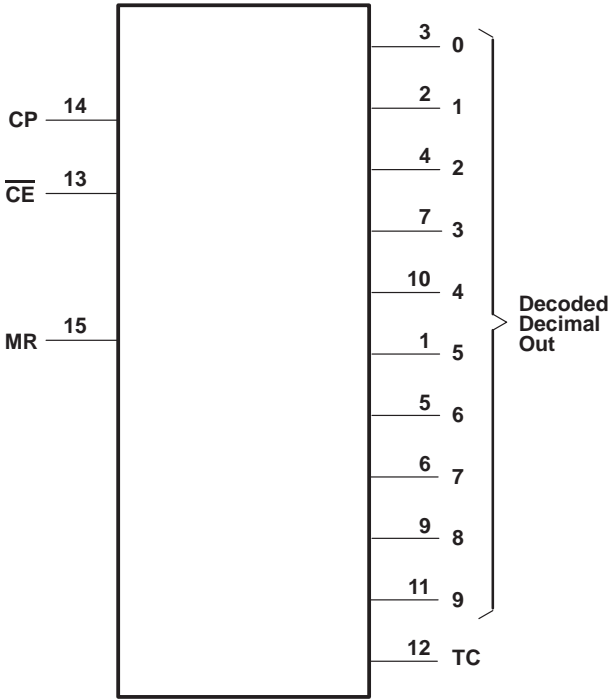
FUNCTION TABLE

INPUTS			OUTPUT STATE†
CP	$\overline{\text{CE}}$	MR	
L	X	L	No change
X	H	L	No change
X	X	H	0 = H, 1–9 = L
↑	L	L	Increments counter
↓	X	L	No change
X	↑	L	No change
H	↓	L	Increments counter

NOTE: H = high voltage level, L = low voltage level,
X = don't care, ↑ = transition from low to high
level, ↓ = transition from high to low level

† If $n < 5$, TC = H, otherwise TC = L

logic diagram (positive logic)



CD74HC4017-Q1

HIGH-SPEED CMOS LOGIC DECADE COUNTER/DIVIDER WITH 10 DECODED OUTPUTS

SCLS546 – OCTOBER 2003

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC} (see Note 1)	–0.5 V to 7 V
Input clamp current, I_{IK} ($V_I < -0.5$ V or $V_I > V_{CC} + 0.5$ V)	±20 mA
Output clamp current, I_{OK} ($V_O < -0.5$ V or $V_O > V_{CC} + 0.5$ V)	±20 mA
Source or sink current per output pin, I_O ($V_O > -0.5$ V or $V_O < V_{CC} + 0.5$ V)	±25 mA
Continuous current through V_{CC} or GND	±50 mA
Package thermal impedance, θ_{JA} (see Note 2): M package	73°C/W
PW package	108°C/W
Maximum junction temperature, T_J	150°C
Lead temperature (during soldering):	
At distance $1/16 \pm 1/32$ inch (1.59 ± 0.79 mm) from case for 10 s max	300°C
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltages referenced to GND unless otherwise specified.
2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

		MIN	MAX	UNIT
V_{CC}	Supply voltage	2	6	V
V_{IH}	High-level input voltage	$V_{CC} = 2$ V	1.5	V
		$V_{CC} = 4.5$ V	3.15	
		$V_{CC} = 6$ V	4.2	
V_{IL}	Low-level input voltage	$V_{CC} = 2$ V	0.5	V
		$V_{CC} = 4.5$ V	1.35	
		$V_{CC} = 6$ V	1.8	
V_I	Input voltage	0	V_{CC}	V
V_O	Output voltage	0	V_{CC}	V
t_t	Input transition (rise and fall) time	$V_{CC} = 2$ V	0	1000
		$V_{CC} = 4.5$ V	0	500
		$V_{CC} = 6$ V	0	400
T_A	Operating free-air temperature	–40	125	°C

- NOTES: 3. All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



CD74HC4017-Q1

HIGH-SPEED CMOS LOGIC DECADE COUNTER/DIVIDER

WITH 10 DECODED OUTPUTS

SCLS546 – OCTOBER 2003

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		I _O (mA)	V _{CC}	T _A = 25°C		MIN	MAX	UNIT
					MIN	MAX			
V _{OH}	V _I = V _{IH} or V _{IL}	CMOS loads	−0.02	2 V	1.9		1.9		V
			−0.02	4.5 V	4.4		4.4		
			−0.02	6 V	5.9		5.9		
		TTL loads	−4	4.5 V	3.98		3.7		
			−5.2	6 V	5.48		5.2		
V _{OL}	V _I = V _{IH} or V _{IL}	CMOS loads	0.02	2 V	0.1		0.1		V
			0.02	4.5 V	0.1		0.1		
			0.02	6 V	0.1		0.1		
		TTL loads	4	4.5 V	0.26		0.4		
			5.2	6 V	0.26		0.4		
I _I	V _I = V _{CC} or GND			6 V	±0.1		±1		μA
I _{CC}	V _I = V _{CC} or GND		0	6 V	8		160		μA
C _{IN}	C _L = 50 pF				10		10		pF

timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER			V _{CC}	T _A = 25°C		MIN	MAX	UNIT
				MIN	MAX			
f _{max} Maximum clock frequency			2 V	6		4		MHz
			4.5 V	30		20		
			6 V	35		23		
t _w	Pulse duration	CP	2 V	80		120		ns
			4.5 V	16		24		
			6 V	14		20		
		MR	2 V	80		120		
			4.5 V	16		24		
			6 V	14		20		
t _{su}	Setup time	$\overline{\text{CE}}$ to CP	2 V	75		110		ns
			4.5 V	15		22		
			6 V	13		19		
		MR inactive	2 V	5		5		
			4.5 V	5		5		
			6 V	5		5		
t _h Hold time, $\overline{\text{CE}}$ to CP			2 V	0		0		ns
			4.5 V	0		0		
			6 V	0		0		



CD74HC4017-Q1
HIGH-SPEED CMOS LOGIC DECADE COUNTER/DIVIDER
WITH 10 DECODED OUTPUTS

SCLS546 – OCTOBER 2003

switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	V _{CC}	T _A = 25°C			MIN	MAX	UNIT
					MIN	TYP	MAX			
t _{pd}	CP	Decade out	C _L = 50 pF	2 V			230		345	ns
				4.5 V			46		69	
				6 V			39		59	
			C _L = 15 pF	5 V		19				
		TC	C _L = 50 pF	2 V			230		345	
				4.5 V			46		69	
				6 V			39		59	
			C _L = 15 pF	5 V		19				
	$\overline{\text{CE}}$	Decade out	C _L = 50 pF	2 V			250		375	
				4.5 V			50		75	
				6 V			43		64	
			C _L = 15 pF	5 V		21				
		TC	C _L = 50 pF	2 V			250		375	
				4.5 V			50		75	
				6 V			43		64	
			C _L = 15 pF	5 V		21				
	MR	Decade out	C _L = 50 pF	2 V			230		345	
				4.5 V			46		69	
				6 V			39		59	
			C _L = 15 pF	5 V		19				
		TC	C _L = 50 pF	2 V			230		345	
				4.5 V			46		69	
				6 V			39		59	
			C _L = 15 pF	5 V		19				
t _t		TC, Decade out	C _L = 50 pF	2 V			75		110	ns
				4.5 V			15		22	
				6 V			13		19	
f _{max}	CP		C _L = 15 pF	5 V		60				MHz

operating characteristics, V_{CC} = 5 V, T_A = 25°C, input t_r, t_f = 6 ns, C_L = 15 pF

PARAMETER	TYP	UNIT
C _{pd} Power dissipation capacitance (see Note 4)	39	pF

NOTE 4: C_{pd} is used to determine the dynamic power consumption per package.

$$P_D = (C_{pd} \times V_{CC}^2 \times f_i) + \Sigma(C_L \times V_{CC}^2 \times f_O)$$

f_i = input frequency

f_O = output frequency

C_L = output load capacitance

V_{CC} = supply voltage

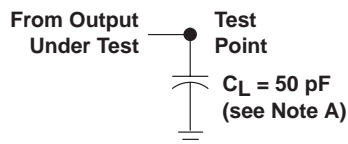
CD74HC4017-Q1

HIGH-SPEED CMOS LOGIC DECADE COUNTER/DIVIDER

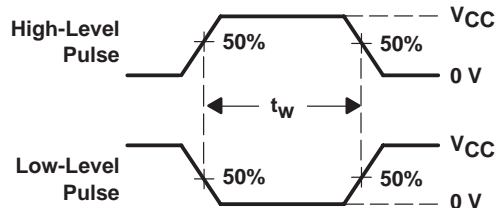
WITH 10 DECODED OUTPUTS

SCLS546 – OCTOBER 2003

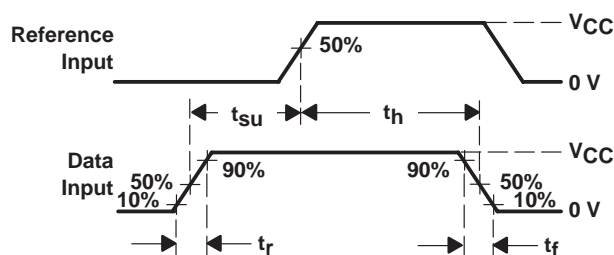
PARAMETER MEASUREMENT INFORMATION



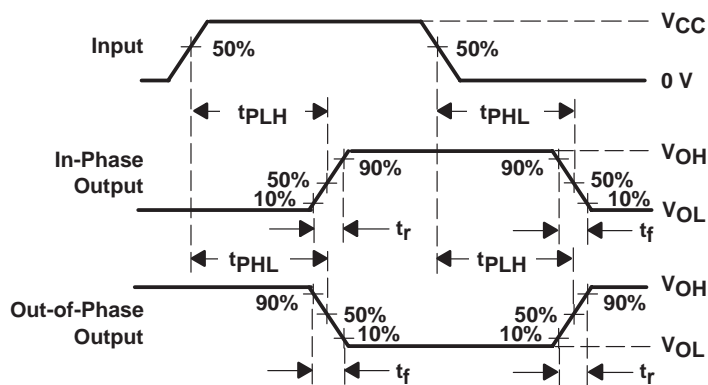
LOAD CIRCUIT



VOLTAGE WAVEFORMS
PULSE DURATIONS



VOLTAGE WAVEFORMS
SETUP AND HOLD AND INPUT RISE AND FALL TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY AND OUTPUT TRANSITION TIMES

- NOTES:
- C_L includes probe and test-fixture capacitance.
 - Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: $PRR \leq 1 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r = 6 \text{ ns}$, $t_f = 6 \text{ ns}$.
 - For clock inputs, f_{max} is measured when the input duty cycle is 50%.
 - The outputs are measured one at a time with one input transition per measurement.
 - t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 1. Load Circuit and Voltage Waveforms



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE

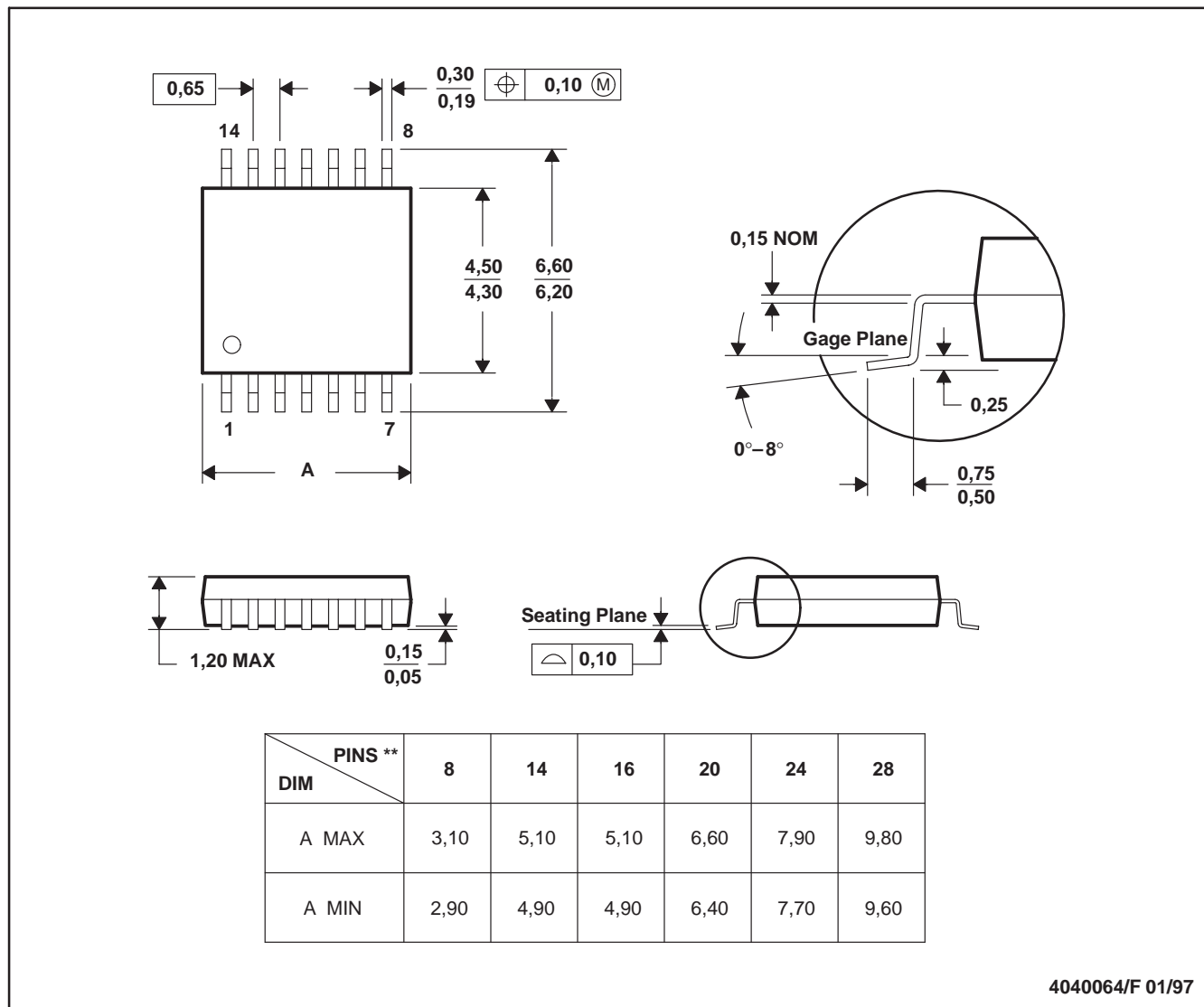


- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - Falls within JEDEC MS-012 variation AC.

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 - Falls within JEDEC MO-153

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
		Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments
Post Office Box 655303 Dallas, Texas 75265

Copyright © 2004, Texas Instruments Incorporated